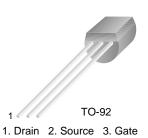
April 2008



# **U1897 N-Channel JFET Switch**

### Features

- This device is designed for low level analog switching, sample and hold circuits and chopper stabalized amplifiers.
- Sourced from Process 51.
- See J111 for characteristics.



## Absolute Maximum Ratings \* Ta=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>DG</sub>	Drain-Gate Voltage	40	V
V <sub>GS</sub>	Gate-Source Voltage	-40	V
I <sub>GF</sub>	Forward Gate Current	50	mA
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 ~ 150	°C

\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired. NOTES:

These ratings are based on a maximum junction temperature of 150°C.
These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### Thermal Characteristics\* Ta=25°C unless otherwise noted

Symbol	Parameter	Value	Units
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	625 5.0	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	°C/W
R <sub>0JA</sub>	Thermal Resistance, Junction to Ambient	357	°C/W

\* Device mounted on FR-4 PCB 1.6" × 1.6" × 0.06

# Electrical Characteristics \* $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Max	Units
Off Charact	teristics	•	1		
V <sub>(BR)GS</sub>	Gate-Source Breakdown Voltage	$I_{G} = -1.0 \ \mu A, \ V_{DS} = 0$	-40		V
V <sub>GS(off)</sub>	Gate-Source Cutoff Voltage	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 1.0 nA	-5.0	-10	V
I <sub>DGO</sub>	Drain-Gate Leakage Current	$V_{DG} = 20 \text{ V}, \text{ I}_{S} = 0$		-200	pА
On Charact	teristics		•		
I <sub>DSS</sub>	Zero-Gate Voltage Drain Current *	$V_{DS} = 20 V, V_{GS} = 0$	30		mA
r <sub>DS(on)</sub>	Static Drain-Source On Resistance	$I_{D} = 1.0 \text{ mA}, V_{GS} = 0$		30	Ω
Small Sign	al Characteristics	•	•		
r <sub>ds(on)</sub>	Drain-Source On Resistance	$V_{DS} = V_{GS} = 0$ , f= 1.0 kHz		30	Ω
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 20, V <sub>GS</sub> = 0, f = 1.0 MHz		16	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	V <sub>GS</sub> = -20 V, f = 1.0 MHz		3.5	pF
Switching (	Characteristics				
t <sub>on</sub>	Turn-On Time	I <sub>D(on)</sub> = 6.6 mA		25	ns
t <sub>off</sub>	Turn-Off Time	V <sub>GS(off)</sub> = 12.0 V		40	ns

\* Pulse Test: Pulse Width  $\leq 300 \mu s,$  Duty Cycle  $\leq 2.0\%$ 

#### NOTES:

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These ratings are based on a maximum junction temperature of 150degrees C.

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